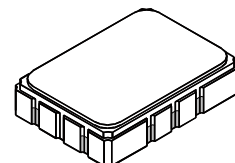


- Designed for SDARS IF Receiver
- Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- Differential or Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)
- Moisture Sensitivity Level: 1
- AEC-Q200 Qualified

SF2040B

**80.460 MHz
SAW Filter**



SMP-03

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_c			80.460		MHz
Passband Insertion Loss	IL			9.5	12.0	dB
1dB Passband	BW ₁		3.7	4.1		MHz
15dB Bandwidth	BW ₁₅			6.6	6.7	MHz
30dB Bandwidth	BW ₃₀			7.6	7.7	MHz
Amplitude Ripple over $f_c \pm 1.85$ MHz				0.5	1.10	dB _{P-P}
Group Delay Variation over $f_c \pm 1.85$ MHz	GDV			60	150	ns _{P-P}
Rejection 50 to 74.39 MHz			40	44		dB
74.39 to 75.99 MHz			38	40		
85.21 to 86.5 MHz			40	44		
86.5 to 91.50 MHz			45	48		
91.50 to 100 MHz			45	53		
Operating Temperature Range	T _A		-40		+85	°C
Frequency Temperature Coefficient	FTC			-18		ppm/°C
Differential Input			175 ohms			
Differential Output			1000 ohms			
Case Style			SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift, ## = Sequence Code)			RFM, SF2040B, YYWWS##			

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others



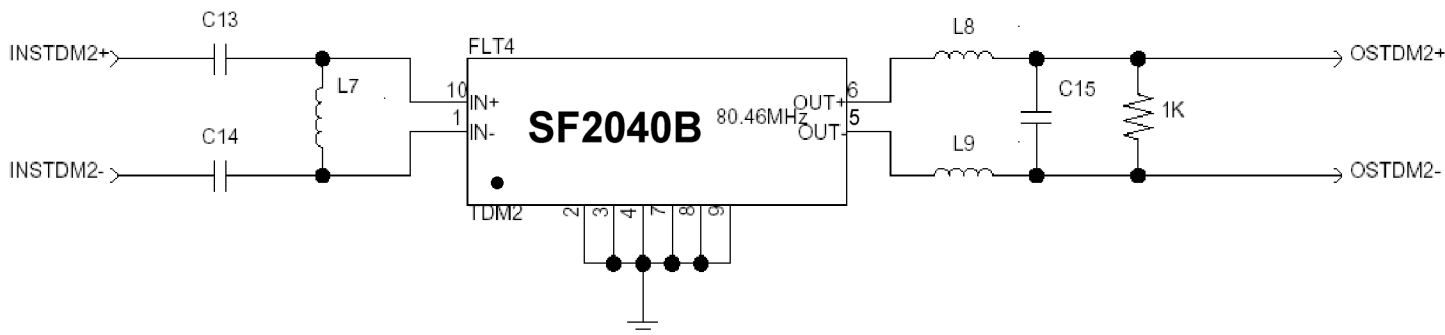
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

Matching Circuit and Matching Component Values Used in G3 Sirius Radios

(Refer to Sirius Radio G3 Chipset Application Note, Doc. #RX000104-B, Sec. 4.2.5)

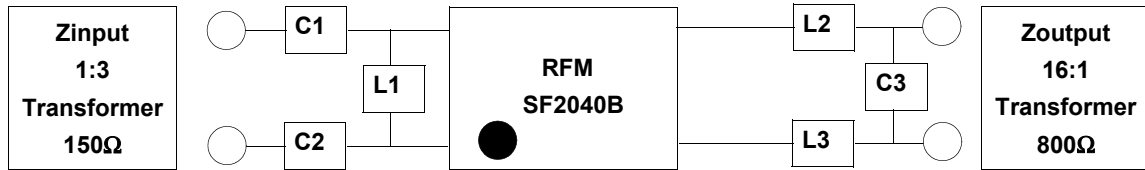


TDM2 Narrowband SAW Matching Circuit

TDM2 Narrowband SAW Matching Values

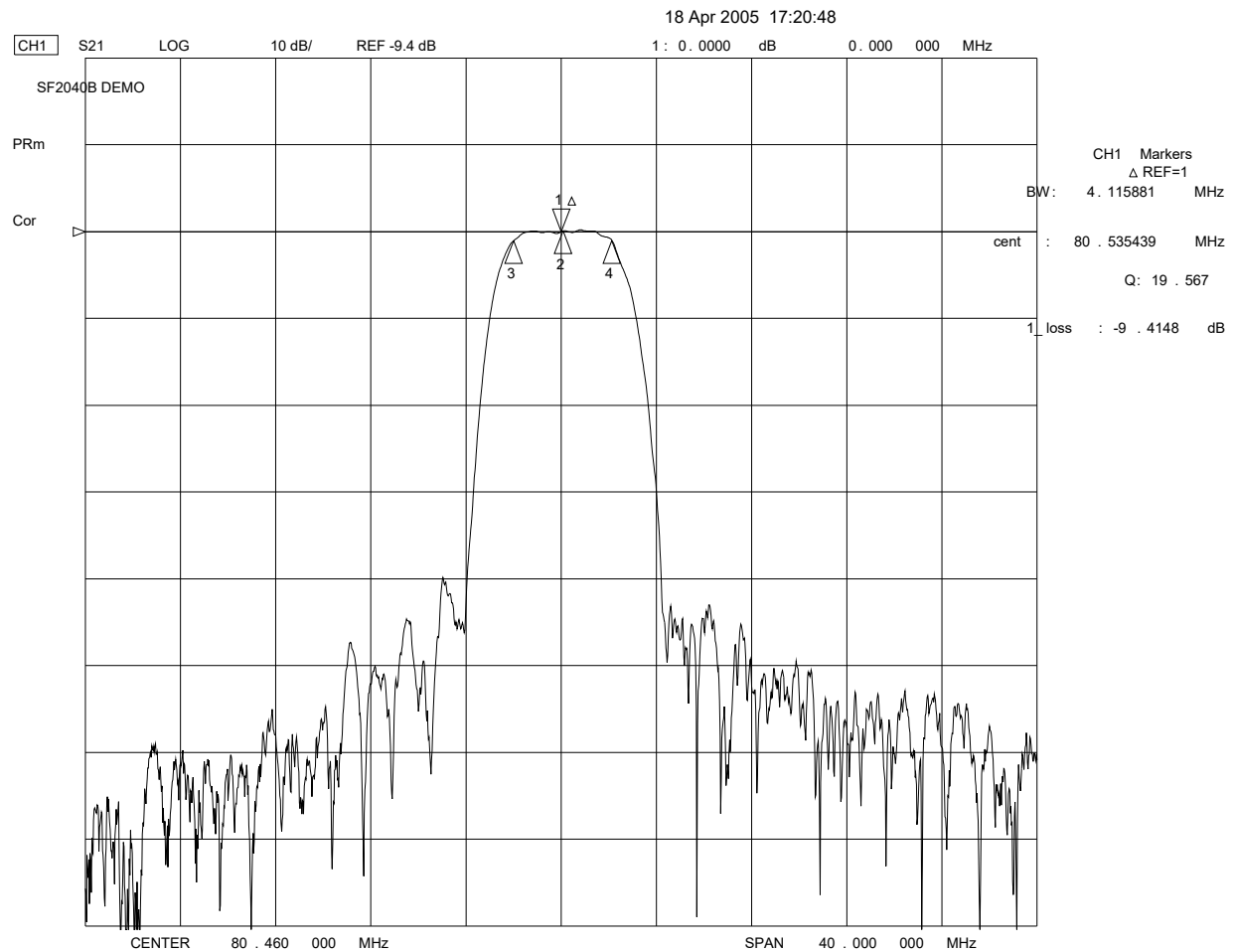
Reference Designator	Value
C13	12 pF
C14	12 pF
L7	240 nH
L8	390 nH
L9	390 pF
C15	10 pF

Matching Circuit and Matching Component Values Used on Filter Demo Board

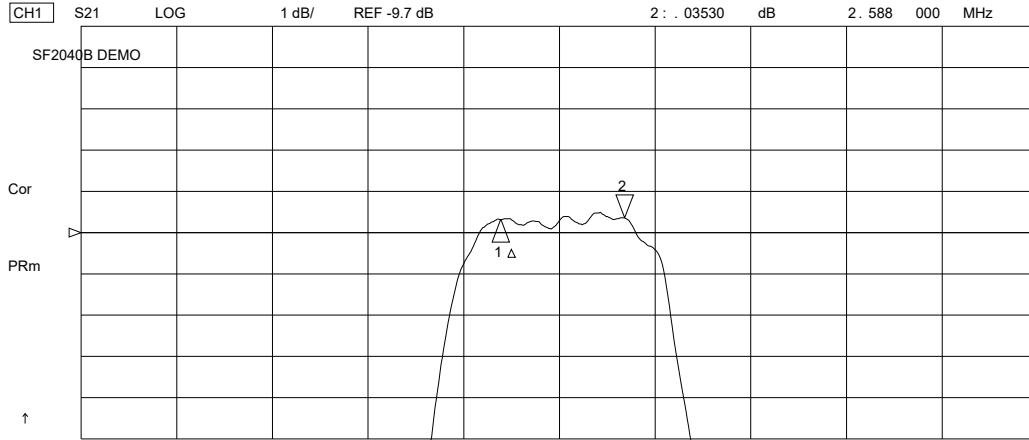


SF2040B
80.460 MHz

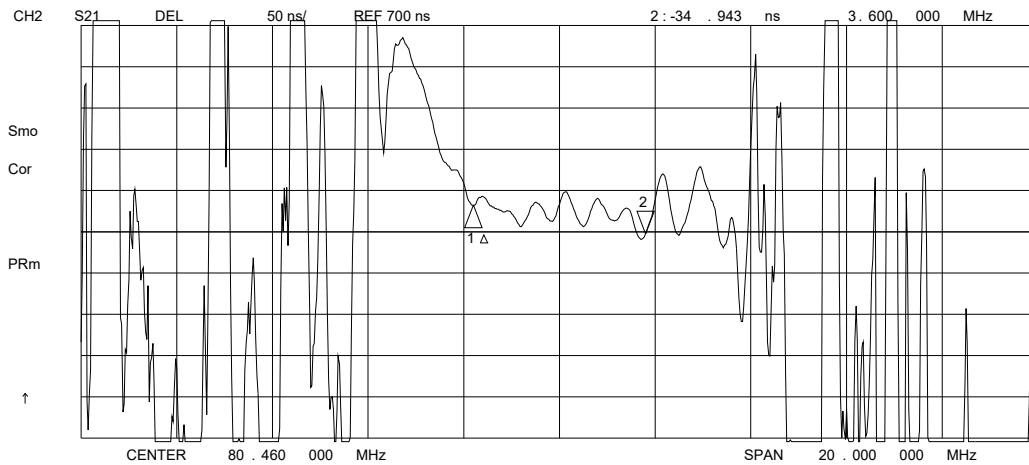
C1 = 9pF
C2 = 9pF
L1 = 270nH
L2 = 330nH
L3 = 330pF
C3 = 12pF



18 Apr 2005 17:17:25



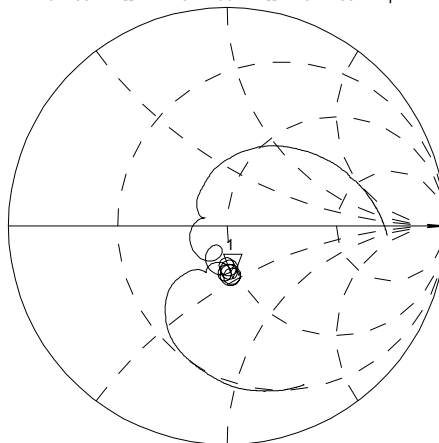
CH1 Markers
 Δ REF=1
 mean : -9 . 4041 dB
 s . dev : . 09650 dB
 p-p : . 39870 dB



CH2 Markers
 Δ REF=1
 mean : 723 . 53 ns
 s . dev : 12 . 938 ns
 p-p : 57 . 755 ns

18 Apr 2005 17:09:52
 CH1 S11 1 UFS 1 : 46 . 854 Ω -23 . 961 Ω 82 . 554 pF 80 . 460 000 MHz
 SF2040B DEMO

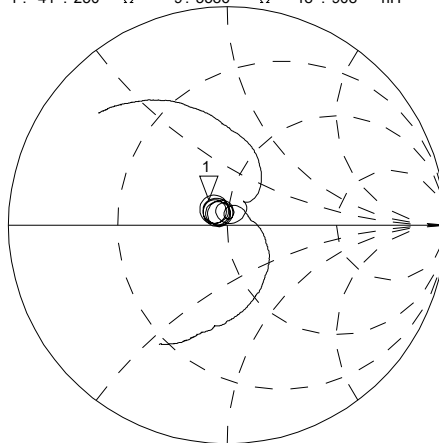
PRm



↑

CH2 S22 1 UFS 1 : 41 . 250 Ω 9 . 5586 Ω 18 . 908 nH 80 . 460 000 MHz

PRm



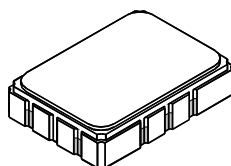
↑

CENTER 80 . 460 000 MHz SPAN 20 . 000 000 MHz

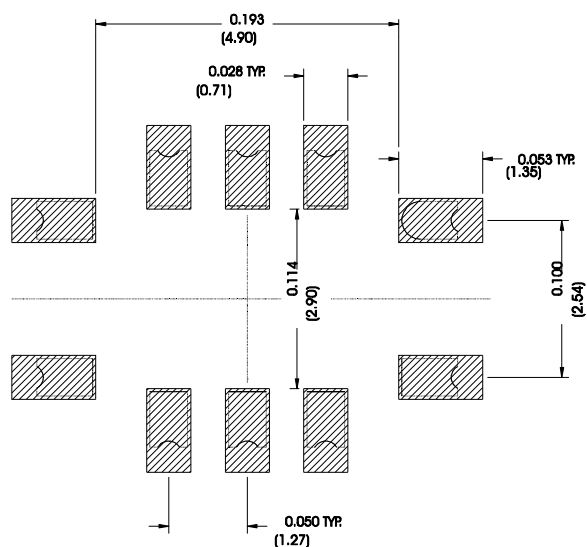
SMP-03 Case

10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



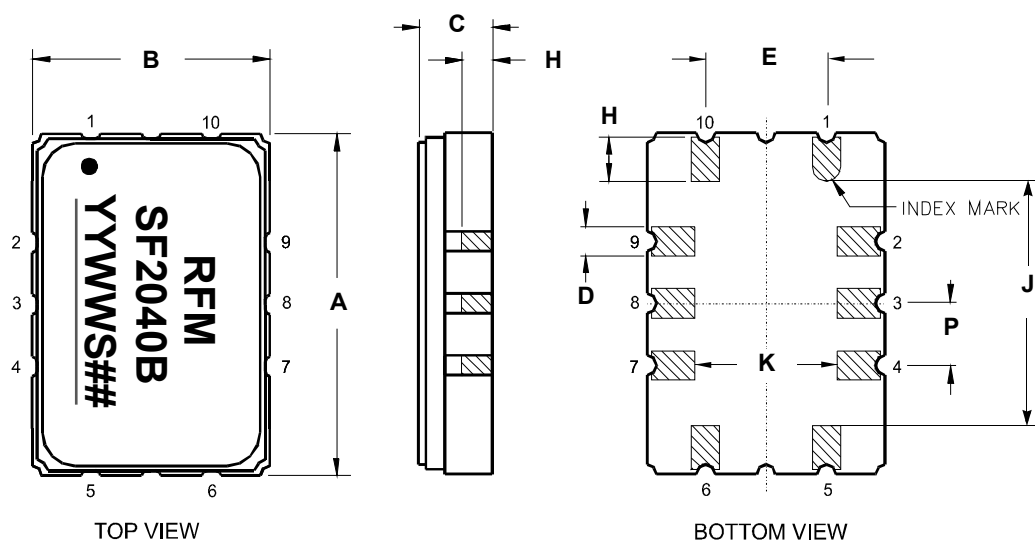
Recommended PCB Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

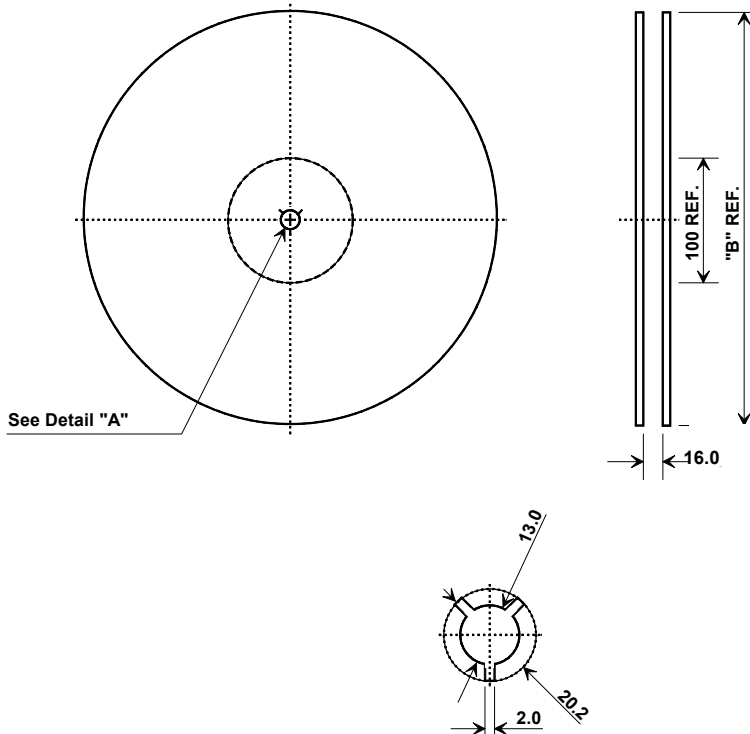
Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



Tape and Reel Specifications

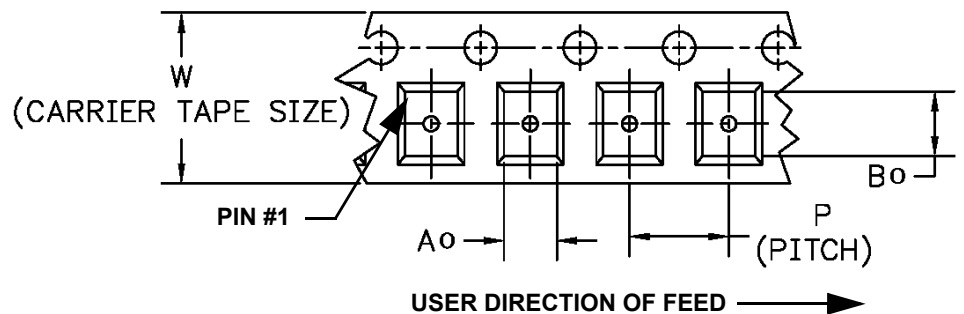
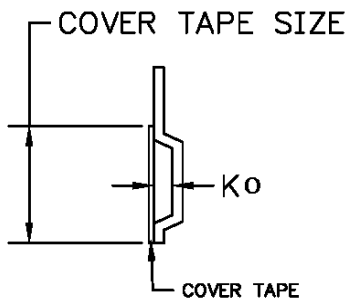
Tape and Reel Standard per ANSI/EIA-481



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

